

INFORMATION DISCLOSURE CITATION

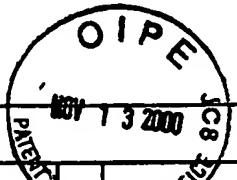
Docket: 550718-077

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Applicant: Haruo Kamei

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Group:



U.S. PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

Wb U.S. Patent Application No. 08/826,344 entitled Method and Apparatus for Grinding the Surface of a Work

* Examiner: Initial if reference considered, whether or not citation is conformance with MPEP 609. Draw line through citation is not in conformance and not considered. Include copy of this form with next communication to applicant.